



DMC4040SSD

40V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

| Device | V _{(BR)DSS} | R _{DS(ON)} Max | I _D Max (A) T _A = +25°C (Notes 6 & 8) |
|--------|----------------------|--------------------------------|-------------------------------------------------------------------|
| Q1 | 40V | 25mΩ @ V _{GS} = 10V | 7.5 |
| Qi | 40 V | 40mΩ @ V _{GS} = 4.5V | 6.2 |
| 02 | 40)/ | 25mΩ @ V _{GS} = -10V | -7.3 |
| Q2 | -40V | 45mΩ @ V _{GS} = -4.5V | -5.7 |

Features and Benefits

- Matched N & P R_{DS(ON)} Minimizes Power Losses
- Fast Switching Minimizes Switching Losses
- Dual Device Reduces PCB Area
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description

This MOSFET is designed to ensure that $R_{DS(ON)}$ of N and P channel FET are matched to minimize losses in both arms of the bridge. The DMC4040SSD is optimized for use in a 3-phase brushless DC motor circuit (BLDC), and CCFL backlighting.

Applications

- 3-Phase BLDC Motor
- CCFL Backlighting

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)

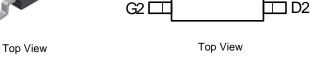
SO-8

oxdot D1

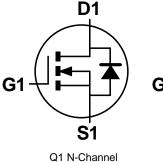
∏ D1

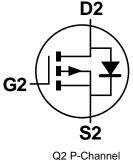
 \Box D2





G1 □





Equivalent Circuit

Ordering Information (Note 4)

| Product | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|---------------|---------|--------------------|-----------------|-------------------|
| DMC4040SSD-13 | C4040SD | 13 | 12 | 2,500 |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



⊃\\ = Manufacturer's MarkingC4040SD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 10 = 2010) WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | N-Channel - Q1 | P-Channel - Q2 | Unit |
|--------------------------------------------------|---------------------------------------|--------------------------------------|------------------|----------------|----------------|------|
| Drain-Source Voltage | | | V_{DSS} | 40 | -40 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | ±20 | l v |
| | | (Notes 6 & 8) | I _D | 7.5 | -7.5 | A |
| Continuous Drain Current | V _{GS} = 10V | T _A = +70°C (Notes 6 & 8) | | 5.8 | -5.8 | |
| | | (Notes 5 & 8) | | 5.7 | -5.7 | |
| | | (Notes 5 & 9) | | 6.8 | -6.8 | |
| Pulsed Drain Current | rent V _{GS} = 10V (Notes 7 & | | I _{DM} | 29.0 | -29.0 | |
| Continuous Source Current (Body Diode) (N | | (Notes 6 & 8) | Is | 3.0 | -3.0 | |
| Pulsed Source Current (Body Diode) (Notes 7 & 8) | | (Notes 7 & 8) | I _{SM} | 29.0 | -29.0 | |

Thermal Characteristics

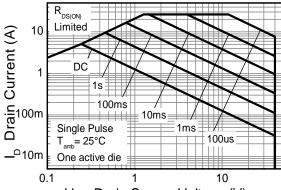
| Characteristic | Symbol | N-Channel - Q1 P-Channel - Q2 | Unit | | |
|---------------------------------------------|----------------|----------------------------------|--------------|------------|--|
| | (Notes 5 & 8) | | 1.25 10 | | |
| Power Dissipation Linear Derating Factor | (Notes 5 & 9) | P _D | 1.8 14.3 | W mW/°C | |
| | (Notes 6 & 8) | | 2.14 17.2 | | |
| | (Notes 5 & 8) | | 100 | °C/W | |
| Thermal Resistance, Junction to Ambient | (Notes 5 & 9) | $R_{\theta JA}$ | 70 | | |
| | (Notes 6 & 8) | | 58 | C/VV | |
| Thermal Resistance, Junction to Lead | (Notes 5 & 10) | R _{0JL} | 51 | | |
| Operating and Storage Temperature Range | | T _{J,} T _{STG} | -55 to +150 | °C | |

Notes:

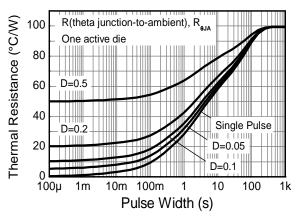
- 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Same as note (5), except the device is measured at $t \le 10$ sec. 7. Same as note (5), except the device is pulsed with D = 0.02 and pulse width 300 μ s. 8. For a dual device with one active die.
- 9. For a device with two active die running at equal power.
- 10. Thermal resistance from junction to solder-point (at the end of the drain lead).



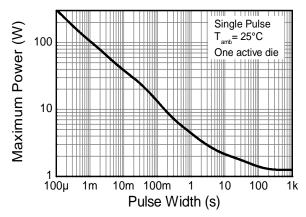
Thermal Characteristics (Continued)



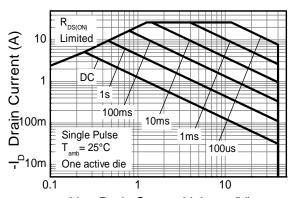
V_{DS} Drain-Source Voltage (V) **N-channel Safe Operating Area**



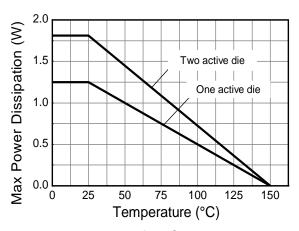
Transient Thermal Impedance



Pulse Power Dissipation



-V_{DS} Drain-Source Voltage (V) **P-channel Safe Operating Area**



Derating Curve



Electrical Characteristics (Q1 N-Channel) (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---------------------------------------------|---------------------|-----|-------|-------|-------|-----------------------------------------------------|--|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 40 | _ | _ | V | $I_D = 250 \mu A, V_{GS} = 0 V$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1.0 | μA | V _{DS} = 40V, V _{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS | | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 0.8 | 1.3 | 1.8 | V | $I_D=250\mu A,\ V_{DS}=V_{GS}$ | |
| Static Drain-Source On-Resistance (Note 11) | D | | 0.013 | 0.025 | Ω | V _{GS} = 10V, I _D = 3A | |
| Static Drain-Source On-Resistance (Note 11) | R _{DS(ON)} | | 0.028 | 0.040 | 12 | V _{GS} = 4.5V, I _D = 3A | |
| Forward Transconductance (Notes 11 & 12) | G _{fs} | _ | 12.6 | | S | V _{DS} = 5V, I _D = 3A | |
| Diode Forward Voltage (Note 11) | V_{SD} | _ | 0.7 | 1.0 | V | I _S = 1A, V _{GS} = 0V | |
| DYNAMIC CHARACTERISTICS (Note 12) | | | | | | | |
| Input Capacitance | Ciss | _ | 1,790 | _ | | V 00V V 0V | |
| Output Capacitance | Coss | _ | 160 | | pF | V_{DS} = 20V, V_{GS} = 0V f= 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 120 | | | | |
| Gate Resistance | R_g | _ | 1.03 | _ | Ω | V _{DS} = 0V, V _{GS} = 0V, f= 1MHz | |
| Total Gate Charge (Note 13) | Q_g | _ | 16.0 | _ | | V _{GS} = 4.5V | |
| Total Gate Charge (Note 13) | Qg | _ | 37.6 | _ | nC | V _{DS} = 20V | |
| Gate-Source Charge (Note 13) | Qgs | _ | 7.8 | _ | nc nc | $V_{GS}=10V$ $I_{D}=3A$ | |
| Gate-Drain Charge (Note 13) | Q_{gd} | _ | 6.6 | _ | | | |
| Turn-On Delay Time (Note 13) | t _{D(on)} | _ | 8.1 | _ | _ | | |
| Turn-On Rise Time (Note 13) | t _r | _ | 15.1 | 1 | nS | V_{DD} = 20V, V_{GS} = 10V I_{D} = 3A | |
| Turn-Off Delay Time (Note 13) | t _{D(off)} | _ | 24.3 | _ | 110 | | |
| Turn-Off Fall Time (Note 13) | t _f | | 5.3 | _ | | | |

Electrical Characteristics (Q2 P-Channel) (@TA = +25°C, unless otherwise specified.)

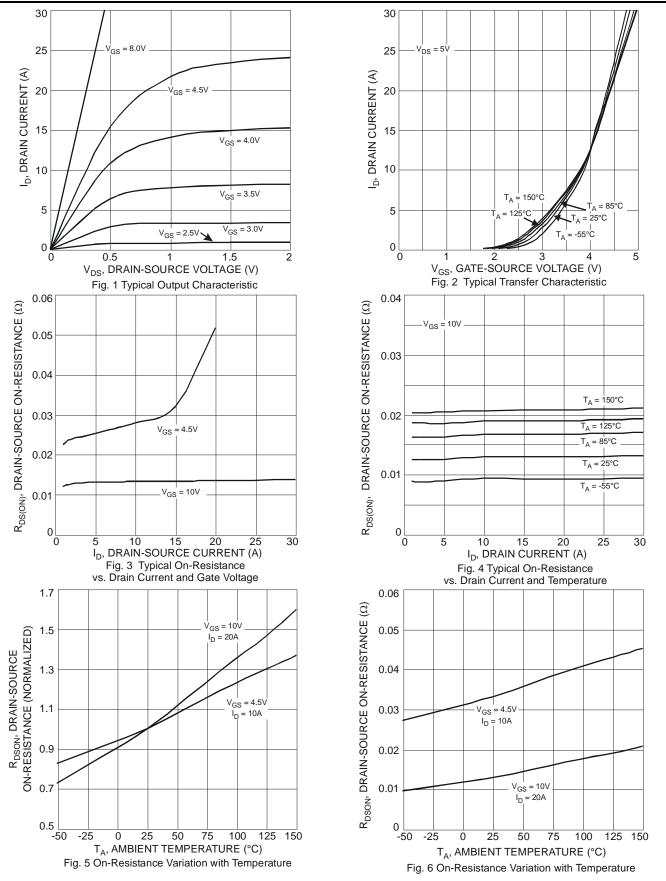
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | | |
|---------------------------------------------|---------------------|------|-------|-------|------|----------------------------------------------------------|---------------------------------|--|
| OFF CHARACTERISTICS | | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -40 | _ | _ | V | $I_D = -250\mu A, V_{GS} = 0V$ | | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | -1.0 | μA | | $V_{DS} = -40V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | Igss | _ | _ | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | |
| ON CHARACTERISTICS | | | | | | • | | |
| Gate Threshold Voltage | V _{GS(th)} | -0.8 | -1.3 | -1.8 | V | $I_D = -250 \mu A, V_{DS}$ | = V _{GS} | |
| Static Drain Source On Registence (Note 11) | <u> </u> | _ | 0.018 | 0.025 | Ω | $V_{GS} = -10V, I_{D} =$ | -3A | |
| Static Drain-Source On-Resistance (Note 11) | R _{DS(ON)} | | 0.030 | 0.045 | 1 12 | $V_{GS} = -4.5V, I_{D} =$ | -3A | |
| Forward Transconductance (Notes 11 & 12) | Gfs | _ | 16.6 | _ | S | V _{DS} = -5V, I _D = -3A | | |
| Diode Forward Voltage (Note 11) | V _{SD} | _ | -0.7 | -1.0 | V | $I_S = -1A, V_{GS} = 0V$ | | |
| DYNAMIC CHARACTERISTICS (Note 12) | | | | | | | | |
| Input Capacitance | C _{iss} | _ | 1,643 | _ | | V _{DS} = -20V, V _{GS} = 0V f = 1MHz | | |
| Output Capacitance | Coss | _ | 179 | _ | pF | | | |
| Reverse Transfer Capacitance | C _{rss} | _ | 128 | _ | | | | |
| Gate Resistance | Rg | _ | 6.43 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | | |
| Total Gate Charge (Note 13) | Qq | _ | 14.0 | _ | | $V_{GS} = -4.5V$ | | |
| Total Gate Charge (Note 13) | Qg | _ | 33.7 | _ | | $V_{GS} = -10V$ $V_{DS} = -20V$ $I_{D} = -3A$ | $V_{DS} = -20V$ | |
| Gate-Source Charge (Note 13) | Q _{gs} | _ | 5.5 | _ | nC | | $I_D = -3A$ | |
| Gate-Drain Charge (Note 13) | Q _{qd} | _ | 7.3 | _ | | | | |
| Turn-On Delay Time (Note 13) | t _{D(on)} | _ | 6.9 | _ | | | • | |
| Turn-On Rise Time (Note 13) | tr | _ | 14.7 | _ | ~0 | $V_{DD} = -20V, V_{GS} = -10V$ $I_{D} = -3A$ | | |
| Turn-Off Delay Time (Note 13) | t _{D(off)} | _ | 53.7 | _ | nS | | | |
| Turn-Off Fall Time (Note 13) | t _f | _ | 30.9 | _ | 1 | | | |

Notes:

- 11. Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$
- 12. For design aid only, not subject to production testing.
 13. Switching characteristics are independent of operating junction temperatures.



Typical Characteristics (Q1 N-Channel)







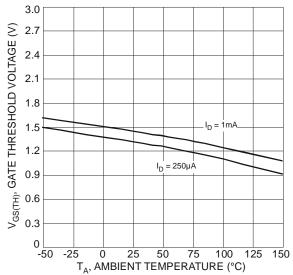
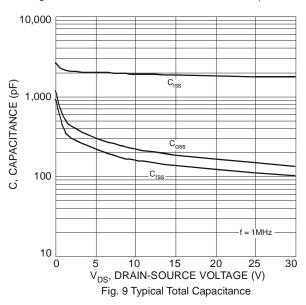
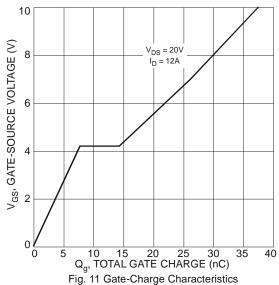
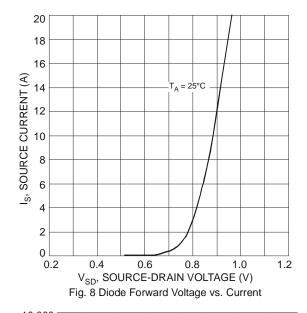
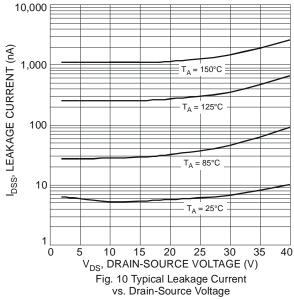


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



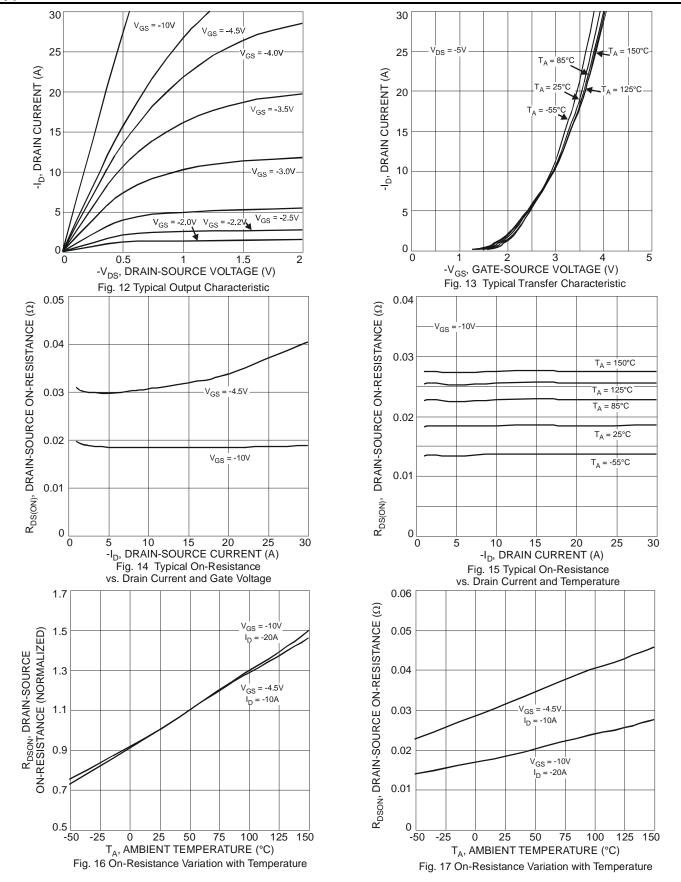








Typical Characteristics (Q2 P-Channel)







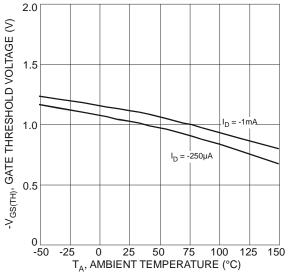
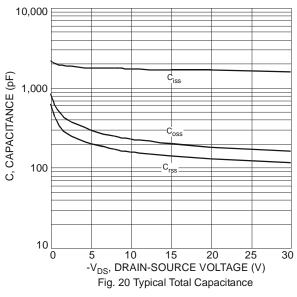
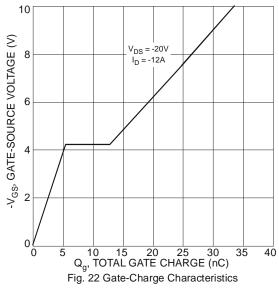
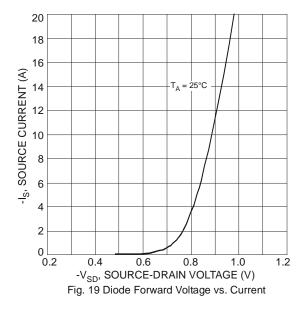
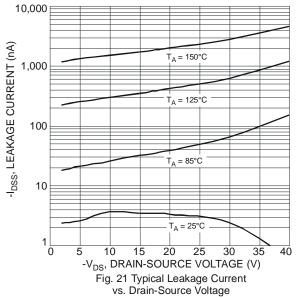


Fig. 18 Gate Threshold Variation vs. Ambient Temperature







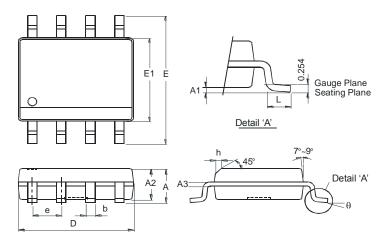




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

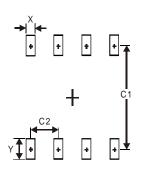




| | SO-8 | | | | | |
|----------------------|------|------|--|--|--|--|
| Dim | Min | Max | | | | |
| Α | _ | 1.75 | | | | |
| A1 | 0.10 | 0.20 | | | | |
| A2 | 1.30 | 1.50 | | | | |
| A3 | 0.15 | 0.25 | | | | |
| b | 0.3 | 0.5 | | | | |
| D | 4.85 | 4.95 | | | | |
| Е | 5.90 | 6.10 | | | | |
| E1 | 3.85 | 3.95 | | | | |
| е | 1.27 | Тур | | | | |
| h | _ | 0.35 | | | | |
| L | 0.62 | 0.82 | | | | |
| θ | 0° | 8° | | | | |
| All Dimensions in mm | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SO-8

| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Υ | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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